SN74HC/HCT165 (LX)
8-bit Parallel-in, Serial out Shift Register

Product Specification

Specification Revision History：

Version	Date	Description
2021-12-A1	2021-12	New

1、General Description

The SN74HC/HCT165 is 8-bit serial or parallel-in/serial-out shift registers. The device features a serial data input (DS), eight parallel data inputs (D0 to D7) and two complementary serial outputs (Q7 and $\overline{Q7}$). When the parallel load input ($\overline{PL}$) is LOW the data from D0 to D7 is loaded into the shift register asynchronously. When $\overline{PL}$ is HIGH data enters the register serially at DS. When the clock enable input ($\overline{CE}$) is LOW data is shifted on the LOW-to-HIGH transitions of the CP input. A HIGH on $\overline{CE}$ will disable the CP input. Inputs are overvoltage tolerant to 15V. This enables the device to be used in HIGH-to-LOW level shifting applications.

Features:

- Input levels:
  For SN74HC165: CMOS level
  For SN74HCT165: TTL level
- Asynchronous 8-bit parallel load
- Synchronous serial input
- Specified from -40℃ to +85℃
- Packaging information: DIP16/SOP16/TSSOP16

Ordering Information:

Tube packing specifications:

Type number	Packaging form	Markingcode	Tube quantity	Boxed tube quantity	Boxed quantity	Packing box number	Packing quantity	Notes
SN74HC165N (LX)	DIP16	SN74HC165N	25 PCS/tube	40 tube/box	1000 PCS/box	10 box/pack	10000 PCS/pack	Dimensions of plastic enclosure: 19.0mm×6.4mm Pin spacing: 2.54mm
SN74HCT165N (LX)	DIP16	SN74HCT165N	25 PCS/tube	40 tube/box	1000 PCS/box	10 box/pack	10000 PCS/pack	Dimensions of plastic enclosure: 19.0mm×6.4mm Pin spacing: 2.54mm

Reel packing specifications:

Type number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Packing quantity	Notes
SN74HC165DR(LX)	SOP16	SN74HC165	4000 PCS/reel	8000 PCS/box	64000 PCS/pack	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing:1.27mm
SN74HCT165DR(LX)	SOP16	SN74HCT165	4000 PCS/reel	8000 PCS/box	64000 PCS/pack	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing:1.27mm
SN74HC165PW(LX)	TSSOP16	SN74HC165	5000 PCS/reel	10000 PCS/box	40000 PCS/pack	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing:0.65mm
SN74HCT165PW(LX)	TSSOP16	SN74HCT165	5000 PCS/reel	10000 PCS/box	40000 PCS/pack	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing:0.65mm

Note: If the physical information is inconsistent with the ordering information, please refer to the actual product.

2、Block Diagram And Pin Description

2.1 、Block Diagram

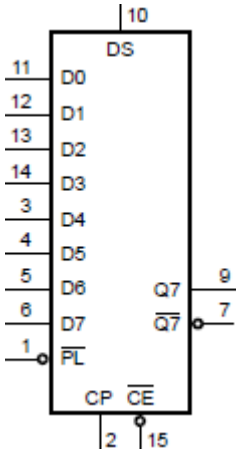


Figure 1. Logic symbol

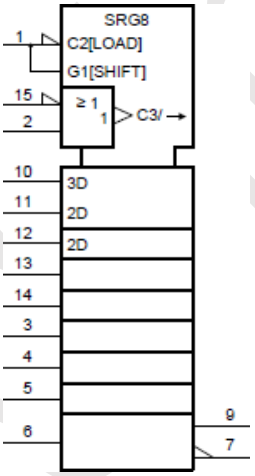


Figure 2. IEC logic symbol

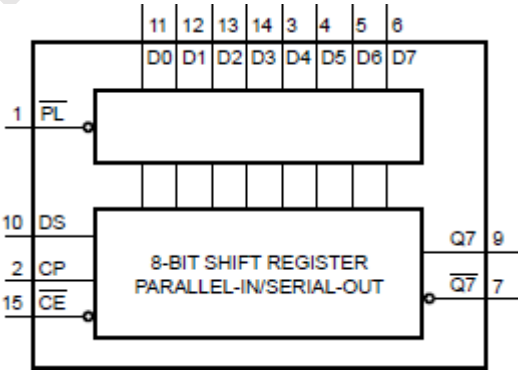


Figure 3. Functional diagram

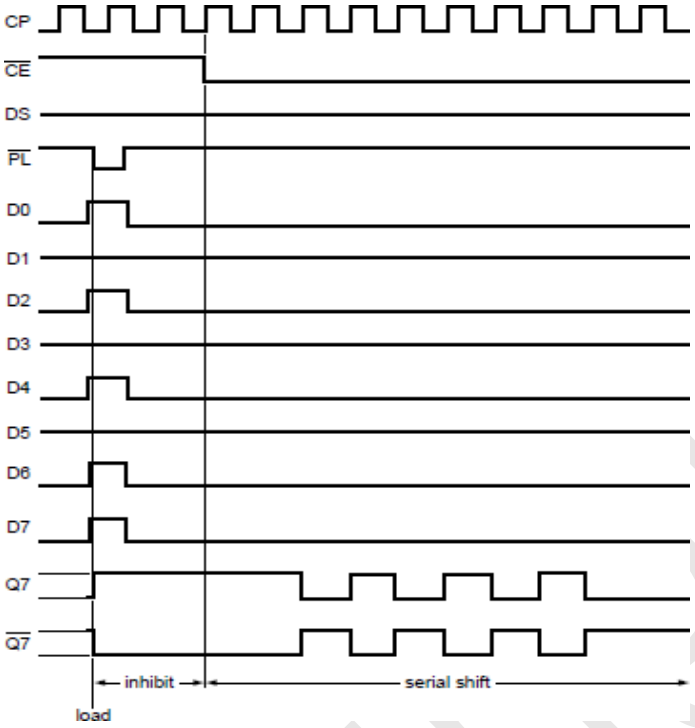
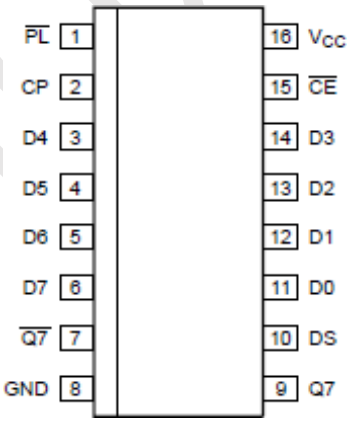


Figure 4. Timing diagram

2.2、Pin Configurations



2.3、Pin Description

Pin No.	Pin Name	Description
1	$\overline{PL}$	asynchronous parallel load input (active LOW)
2	CP	clock input (LOW-to-HIGH, edge-triggered)
3	D4	parallel data input (also referred to as Dn)
4	D5	parallel data input (also referred to as Dn)
5	D6	parallel data input (also referred to as Dn)
6	D7	parallel data input (also referred to as Dn)
7	$\overline{Q7}$	complementary output from the last stage
8	GND	ground (0V)
9	Q7	serial output from the last stage
10	DS	serial data input
11	D0	parallel data input (also referred to as Dn)
12	D1	parallel data input (also referred to as Dn)
13	D2	parallel data input (also referred to as Dn)
14	D3	parallel data input (also referred to as Dn)
15	$\overline{CE}$	clock enable input (active LOW)
16	V_{CC}	supply voltage

2.4、Function Table

Operating mode	Input					Qn register		Output	
	$\overline{PL}$	$\overline{CE}$	CP	DS	D0 to D7	Q0	Q1 to Q6	Q7	$\overline{Q7}$
parallel load	L	X	X	X	L	L	L to L	L	H
	L	X	X	X	H	H	H to H	H	L
serial shift	H	L	↑	l	X	L	q0 to q5	q6	$\overline{q6}$
	H	L	↑	h	X	H	q0 to q5	q6	$\overline{q6}$
	H	↑	L	l	X	L	q0 to q5	q6	$\overline{q6}$
	H	↑	L	h	X	H	q0 to q5	q6	$\overline{q6}$
hold "do nothing"	H	H	X	X	X	q0	q1 to q6	q7	$\overline{q7}$
	H	X	H	X	X	q0	q1 to q6	q7	$\overline{q7}$

Note: H=HIGH voltage level;
h=HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;
L=LOW voltage level; ↑=LOW-to-HIGH clock transition;
l=LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;
q=state of the referenced output one set-up time prior to the LOW-to-HIGH clock transition;
X=don't care;
↑=LOW-to-HIGH clock transition.

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(Voltages are referenced to GND(ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Max.	Unit
supply voltage	V_{CC}	-		-0.5	+7	V
input clamping current	I_{IK}	V_I < -0.5V or V_I > V_{CC}+0.5V		-	±20	mA
output clamping current	I_{OK}	V_O < -0.5V or V_O > V_{CC}+0.5V		-	±20	mA
output current	I_O	-0.5V < V_O < V_{CC}+0.5V		-	±25	mA
supply current	I_{CC}	-		-	50	mA
ground current	I_{GND}	-		-50	-	mA
total power dissipation	P_{tot}	-		-	500	mW
storage temperature	T_{stg}	-		-65	+150	℃
soldering temperature	T_L	10s	DIP	245		℃
			SOP	250		℃

Note:

[1] For DIP16 packages: above 70℃ the value of P_{tot} derates linearly with 12mW/K.

[2] For SOP16 packages: above 70℃ the value of P_{tot} derates linearly with 8mW/K.

[3] For (T)SSOP16 packages: above 60℃ the value of P_{tot} derates linearly with 5.5mW/K.

3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
SN74HC165						
supply voltage	V_{CC}	-	2.0	5.0	6.0	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
input transition rise and fall rate	Δt/ΔV	V_{CC}=2.0V	-	-	625	ns/V
		V_{CC}=4.5V	-	1.67	139	ns/V
		V_{CC}=6.0V	-	-	83	ns/V
ambient temperature	T_{amb}	-	-40	-	+85	℃
SN74HCT165						
supply voltage	V_{CC}	-	4.5	5.0	5.5	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
input transition rise and fall rate	Δt/ΔV	V_{CC}=2.0V	-	-	-	ns/V
		V_{CC}=4.5V	-	1.67	139	ns/V
		V_{CC}=6.0V	-	-	-	ns/V
ambient temperature	T_{amb}	-	-40	-	+85	℃

3.3 、Electrical Characteristics

3.3.1、DC Characteristics 1

(T_{amb}=25℃, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC165							
HIGH-level input voltage	V_{IH}	V_{CC}=2.0V		1.5	1.2	-	V
		V_{CC}=4.5V		3.15	2.4	-	V
		V_{CC}=6.0V		4.2	3.2	-	V
LOW-level input voltage	V_{IL}	V_{CC}=2.0V		-	0.8	0.5	V
		V_{CC}=4.5V		-	2.1	1.35	V
		V_{CC}=6.0V		-	2.8	1.8	V
HIGH-level output voltage	V_{OH}	V_I = V_{IH} or V_{IL}	I_O=-20uA; V_{CC}=2.0V	1.9	2.0	-	V
			I_O=-20uA; V_{CC}=4.5V	4.4	4.5	-	V
			I_O=-20uA; V_{CC}=6.0V	5.9	6.0	-	V
			I_O=-4.0mA; V_{CC}=4.5V	3.98	4.32	-	V
			I_O=-5.2mA; V_{CC}=6.0V	5.48	5.81	-	V
LOW-level output voltage	V_{OL}	V_I = V_{IH} or V_{IL}	I_O=20uA; V_{CC}=2.0V	-	0	0.1	V
			I_O=20uA; V_{CC}=4.5V	-	0	0.1	V
			I_O=20uA; V_{CC}=6.0V	-	0	0.1	V
			I_O=4.0mA; V_{CC}=4.5V	-	0.15	0.26	V
			I_O=5.2mA; V_{CC}=6.0V	-	0.16	0.26	V
input leakage current	I_I	V_I= V_{CC} or GND; V_{CC}=6.0V		-	-	±0.1	uA
supply current	I_{CC}	V_I= V_{CC} or GND; I_O=0A; V_{CC}=6.0V		-	-	8	uA
input capacitance	C_I	-		-	3.5	-	pF
SN74HCT165							
HIGH-level input voltage	V_{IH}	V_{CC}=4.5V to 5.5V		2.0	1.6	-	V
LOW-level input voltage	V_{IL}	V_{CC}=4.5V to 5.5V		-	1.2	0.8	V
HIGH-level output voltage	V_{OH}	V_I = V_{IH} or V_{IL}; V_{CC}=4.5V	I_O=-20uA	4.4	4.5	-	V
			I_O=-4.0mA	3.98	4.32	-	V
LOW-level output voltage	V_{OL}	V_I = V_{IH} or V_{IL}	I_O=20uA; V_{CC}=4.5V	-	0	0.1	V
			I_O=5.2mA; V_{CC}=6.0V	-	0.16	0.26	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=6.0V		-	-	±0.1	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=6.0V		-	-	8.0	uA
additional supply current	ΔI_{CC}	per input pin; V_I=V_{CC}-2.1V; other inputs at V_{CC} or GND; V_{CC}=4.5V to 5.5V	Dn and DS inputs	-	35	126	uA
			CP, $\overline{CE}$, and $\overline{PL}$ inputs	-	65	234	uA
input capacitance	C_I	-		-	3.5	-	pF

3.3.2 、DC Characteristics 2

(T_{amb}=-40℃ to +85℃, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC165							
HIGH-level input voltage	V_{IH}	V_{CC}=2.0V		1.5	-	-	V
		V_{CC}=4.5V		3.15	-	-	V
		V_{CC}=6.0V		4.2	-	-	V
LOW-level input voltage	V_{IL}	V_{CC}=2.0V		-	-	0.5	V
		V_{CC}=4.5V		-	-	1.35	V
		V_{CC}=6.0V		-	-	1.8	V
HIGH-level output voltage	V_{OH}	V_I = V_{IH} or V_{IL}	I_O=-20uA; V_{CC}=2.0V	1.9	-	-	V
			I_O=-20uA; V_{CC}=4.5V	4.4	-	-	V
			I_O=-20uA; V_{CC}=6.0V	5.9	-	-	V
			I_O=-4.0mA; V_{CC}=4.5V	3.84	-	-	V
			I_O=-5.2mA; V_{CC}=6.0V	5.34	-	-	V
LOW-level output voltage	V_{OL}	V_I = V_{IH} or V_{IL}	I_O=20uA; V_{CC}=2.0V	-	-	0.1	V
			I_O=20uA; V_{CC}=4.5V	-	-	0.1	V
			I_O=20uA; V_{CC}=6.0V	-	-	0.1	V
			I_O=4.0mA; V_{CC}=4.5V	-	-	0.33	V
			I_O=5.2mA; V_{CC}=6.0V	-	-	0.33	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=6.0V		-	-	±1	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=6.0V		-	-	80	uA
SN74HCT165							
HIGH-level input voltage	V_{IH}	V_{CC}=4.5V to 5.5V		2.0	-	-	V
LOW-level input voltage	V_{IL}	V_{CC}=4.5V to 5.5V		-	-	0.8	V
HIGH-level output voltage	V_{OH}	V_I = V_{IH} or V_{IL}; V_{CC}=4.5V	I_O=-20uA	4.4	-	-	V
			I_O=-4.0mA	3.84	-	-	V
LOW-level output voltage	V_{OL}	V_I = V_{IH} or V_{IL}	I_O=20uA; V_{CC}=4.5V	-	-	0.1	V
			I_O=5.2mA; V_{CC}=6.0V	-	-	0.33	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=6.0V		-	-	±1	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=6.0V		-	-	80	uA
additional supply current	ΔI_{CC}	per input pin; V_I=V_{CC}-2.1V; other inputs at V_{CC} or GND; V_{CC}=4.5V to 5.5V	Dn and DS inputs	-	-	157.5	uA
			CP, $\overline{CE}$, and $\overline{PL}$ inputs	-	-	292.5	uA

3.3.3 、AC Characteristics 1

(T_{amb}=25℃, GND=0V, C_L=50pf, unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC165							
propagation delay	t_{pd}	CP, $\overline{CE}$ to Q7, $\overline{Q7}$; see Figure 6	V_{CC}=2.0V	-	52	165	ns
			V_{CC}=4.5V	-	19	33	ns
			V_{CC}=5.0V;C_L=15pF	-	16	-	ns
			V_{CC}=6.0V	-	15	28	ns
		$\overline{PL}$ to Q7, $\overline{Q7}$; see Figure 7	V_{CC}=2.0V	-	50	165	ns
			V_{CC}=4.5V	-	18	33	ns
			V_{CC}=5.0V;C_L=15pF	-	15	-	ns
			V_{CC}=6.0V	-	14	28	ns
		D7 to Q7, $\overline{Q7}$; see Figure 8	V_{CC}=2.0V	-	36	120	ns
			V_{CC}=4.5V	-	13	24	ns
			V_{CC}=5.0V;C_L=15pF	-	11	-	ns
			V_{CC}=6.0V	-	10	20	ns
transition time	t_t	Q7, $\overline{Q7}$ output; see Figure 6	V_{CC}=2.0V	-	19	75	ns
			V_{CC}=4.5V	-	7	15	ns
			V_{CC}=6.0V	-	6	13	ns
pulse width	t_W	CP input HIGH or LOW; see Figure 6	V_{CC}=2.0V	80	17	-	ns
			V_{CC}=4.5V	16	6	-	ns
			V_{CC}=6.0V	14	5	-	ns
		$\overline{PL}$ input LOW; see Figure 7	V_{CC}=2.0V	80	14	-	ns
			V_{CC}=4.5V	16	5	-	ns
			V_{CC}=6.0V	14	4	-	ns
recovery time	t_{rec}	$\overline{PL}$ to CP, $\overline{CE}$; see Figure 7	V_{CC}=2.0V	100	22	-	ns
			V_{CC}=4.5V	20	8	-	ns
			V_{CC}=6.0V	17	6	-	ns
set-up time	t_{su}	DS to CP, $\overline{CE}$; see Figure 9	V_{CC}=2.0V	80	11	-	ns
			V_{CC}=4.5V	16	4	-	ns
			V_{CC}=6.0V	14	3	-	ns
		$\overline{CE}$ to CP and CP to $\overline{CE}$; see Figure 9	V_{CC}=2.0V	80	17	-	ns
			V_{CC}=4.5V	16	6	-	ns
			V_{CC}=6.0V	14	5	-	ns
		Dn to $\overline{PL}$; see Figure 10	V_{CC}=2.0V	80	22	-	ns
			V_{CC}=4.5V	16	8	-	ns
			V_{CC}=6.0V	14	6	-	ns
hold time	t_h	DS to CP, $\overline{CE}$ and Dn to $\overline{PL}$; see Figure 9	V_{CC}=2.0V	5	2	-	ns
			V_{CC}=4.5V	5	2	-	ns
			V_{CC}=6.0V	5	2	-	ns
		$\overline{CE}$ to CP and CP to $\overline{CE}$; see Figure 9	V_{CC}=2.0V	5	-17	-	ns
			V_{CC}=4.5V	5	-6	-	ns
			V_{CC}=6.0V	5	-5	-	ns
maximum frequency	f_{max}	CP input; see Figure 6	V_{CC}=2.0V	6	17	-	MHz
			V_{CC}=4.5V	30	51	-	MHz

			V_{CC}=5.0V;C_L=15pF	-	56	-	MHz
			V_{CC}=6.0V	35	61	-	MHz
power dissipation capacitance	C_{PD}	per package; V_I= GND to V_{CC}		-	35	-	pF
SN74HCT165							
propagation delay	t_{pd}	CP, $\overline{CE}$ to Q7, $\overline{Q7}$; see Figure 6	V_{CC}=4.5V	-	17	34	ns
			V_{CC}=5.0V;C_L=15pF	-	14	-	ns
		$\overline{PL}$ to Q7, $\overline{Q7}$; see Figure 7	V_{CC}=4.5V	-	20	40	ns
			V_{CC}=5.0V;C_L=15pF	-	17	-	ns
		D7 to Q7, $\overline{Q7}$; see Figure 8	V_{CC}=4.5V	-	14	28	ns
			V_{CC}=5.0V;C_L=15pF	-	11	-	ns
transition time	t_t	Q7, $\overline{Q7}$ output; see Figure 6	V_{CC}=4.5V	-	7	15	ns
pulse width	t_W	CP input; see Figure 6	V_{CC}=4.5V	16	6	-	ns
		$\overline{PL}$ input; see Figure 7	V_{CC}=4.5V	20	9	-	ns
recovery time	t_{rec}	$\overline{PL}$ to CP, $\overline{CE}$; see Figure 7	V_{CC}=4.5V	20	8	-	ns
set-up time	t_{su}	DS to CP, $\overline{CE}$; see Figure 9	V_{CC}=4.5V	20	2	-	ns
		$\overline{CE}$ to CP and CP to $\overline{CE}$; see Figure 9	V_{CC}=4.5V	20	7	-	ns
		Dn to $\overline{PL}$; see Figure 10	V_{CC}=4.5V	20	10	-	ns
hold time	t_h	DS to CP, $\overline{CE}$ and Dn to $\overline{PL}$; see Figure 9	V_{CC}=4.5V	7	-1	-	ns
		$\overline{CE}$ to CP and CP to $\overline{CE}$; see Figure 9	V_{CC}=4.5V	0	-7	-	ns
maximum frequency	f_{max}	CP input; see Figure 6	V_{CC}=4.5V	26	44	-	MHz
			V_{CC}=5.0V;C_L=15pF	-	48	-	MHz
power dissipation capacitance	C_{PD}	per package; V_I= GND to V_{CC}-1.5V		-	35	-	pF

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.

[2] t_t is the same as t_{THL} and t_{TLH}.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in uW).

$P_D=(C_{PD}\times V_{CC}^2\times f_i\times N)+\sum(C_L\times V_{CC}^2\times f_o)$ where:

f_i=input frequency in MHz;

f_o=output frequency in MHz;

C_L=output load capacitance in pF;

V_{CC}=supply voltage in V;
N=number of inputs switching;
$\sum(C_L \times V_{CC}^2 \times f_o)$=sum of outputs.

3.3.4 、AC Characteristics 2

(T_{amb}=-40℃ to +85℃, GND=0V, C_L=50pf, unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
SN74HC165							
propagation delay	t_{pd}	$\overline{CP}$, $\overline{CE}$ to Q7, $\overline{Q7}$; see Figure 6	V_{CC}=2.0V	-	-	205	ns
			V_{CC}=4.5V	-	-	41	ns
			V_{CC}=6.0V	-	-	35	ns
		$\overline{PL}$ to Q7, $\overline{Q7}$; see Figure 7	V_{CC}=2.0V	-	-	205	ns
			V_{CC}=4.5V	-	-	41	ns
			V_{CC}=6.0V	-	-	35	ns
		D7 to Q7, $\overline{Q7}$; see Figure 8	V_{CC}=2.0V	-	-	150	ns
			V_{CC}=4.5V	-	-	30	ns
			V_{CC}=6.0V	-	-	26	ns
transition time	t_t	Q7, $\overline{Q7}$ output; see Figure 6	V_{CC}=2.0V	-	-	95	ns
			V_{CC}=4.5V	-	-	19	ns
			V_{CC}=6.0V	-	-	16	ns
pulse width	t_W	CP input HIGH or LOW; see Figure 6	V_{CC}=2.0V	100	-	-	ns
			V_{CC}=4.5V	20	-	-	ns
			V_{CC}=6.0V	17	-	-	ns
		$\overline{PL}$ input LOW; see Figure 7	V_{CC}=2.0V	100	-	-	ns
			V_{CC}=4.5V	20	-	-	ns
			V_{CC}=6.0V	17	-	-	ns
recovery time	t_{rec}	$\overline{PL}$ to CP, $\overline{CE}$; see Figure 7	V_{CC}=2.0V	125	-	-	ns
			V_{CC}=4.5V	25	-	-	ns
			V_{CC}=6.0V	21	-	-	ns
set-up time	t_{su}	DS to CP, $\overline{CE}$; see Figure 9	V_{CC}=2.0V	100	-	-	ns
			V_{CC}=4.5V	20	-	-	ns
			V_{CC}=6.0V	17	-	-	ns
		$\overline{CE}$ to CP and CP to $\overline{CE}$; see Figure 9	V_{CC}=2.0V	100	-	-	ns
			V_{CC}=4.5V	20	-	-	ns
			V_{CC}=6.0V	17	-	-	ns
		Dn to $\overline{PL}$; see Figure 10	V_{CC}=2.0V	100	-	-	ns
			V_{CC}=4.5V	20	-	-	ns
			V_{CC}=6.0V	17	-	-	ns
hold time	t_h	DS to CP, $\overline{CE}$ and Dn to $\overline{PL}$; see Figure 9	V_{CC}=2.0V	5	-	-	ns
			V_{CC}=4.5V	5	-	-	ns
			V_{CC}=6.0V	5	-	-	ns
		$\overline{CE}$ to CP and CP to $\overline{CE}$; see Figure 9	V_{CC}=2.0V	5	-	-	ns
			V_{CC}=4.5V	5	-	-	ns
			V_{CC}=6.0V	5	-	-	ns

maximum frequency	f_{max}	CP input; see Figure 6	V_{CC}=2.0V	5	-	-	MHz
			V_{CC}=4.5V	24	-	-	MHz
			V_{CC}=6.0V	28	-	-	MHz
SN74HCT165							
propagation delay	t_{pd}	CP, $\overline{CE}$ to Q7, $\overline{Q7}$; see Figure 6	V_{CC}=4.5V	-	-	43	ns
		$\overline{PL}$ to Q7, $\overline{Q7}$; see Figure 7	V_{CC}=4.5V	-	-	50	ns
		D7 to Q7, $\overline{Q7}$; see Figure 8	V_{CC}=4.5V	-	-	35	ns
transition time	t_t	Q7, $\overline{Q7}$ output; see Figure 6	V_{CC}=4.5V	-	-	19	ns
pulse width	t_W	CP input; see Figure 6	V_{CC}=4.5V	20	-	-	ns
		$\overline{PL}$ input; see Figure 7	V_{CC}=4.5V	25	-	-	ns
recovery time	t_{rec}	$\overline{PL}$ to CP, $\overline{CE}$; see Figure 7	V_{CC}=4.5V	25	-	-	ns
set-up time	t_{su}	DS to CP, $\overline{CE}$; see Figure 9	V_{CC}=4.5V	25	-	-	ns
		$\overline{CE}$ to CP and CP to $\overline{CE}$; see Figure 9	V_{CC}=4.5V	25	-	-	ns
		Dn to $\overline{PL}$; see Figure 10	V_{CC}=4.5V	25	-	-	ns
hold time	t_h	DS to CP, $\overline{CE}$ and Dn to $\overline{PL}$; see Figure 9	V_{CC}=4.5V	9	-	-	ns
		$\overline{CE}$ to CP and CP to $\overline{CE}$; see Figure 9	V_{CC}=4.5V	0	-	-	ns
maximum frequency	f_{max}	CP input; see Figure 6	V_{CC}=4.5V	21	-	-	MHz

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.

[2] t_t is the same as t_{THL} and t_{TLH}.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in uW).

$P_D=(C_{PD}\times V_{CC}^2\times f_i\times N)+\sum(C_L\times V_{CC}^2\times f_o)$ where:

f_i=input frequency in MHz;

f_o=output frequency in MHz;

C_L=output load capacitance in pF;

V_{CC}=supply voltage in V;

N=number of inputs switching;

$\sum(C_L\times V_{CC}^2\times f_o)$=sum of outputs.

4、Testing Circuit

4.1 、AC Testing Circuit

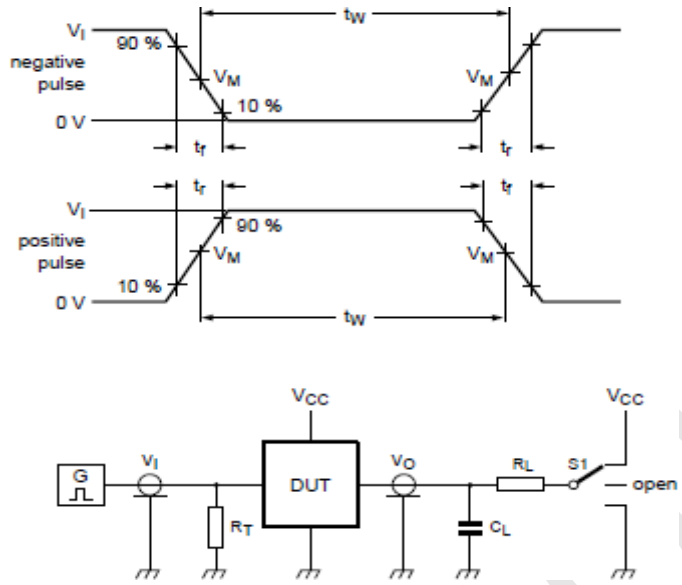


Figure 5. Test circuit for measuring switching times

Definitions for test circuit:

C_L=load capacitance including jig and probe capacitance.

R_T=termination resistance should be equal to the output impedance Z_o of the pulse generator.

RL=Load resistance.

S1=Test selection switch.

4.2 、AC Testing Waveforms

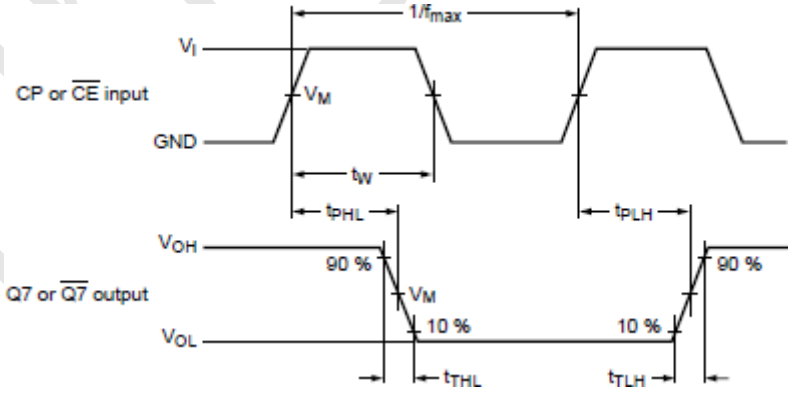


Figure 6. The clock (CP) or clock enable (CE) to output (Q7 or Q7) propagation delays, the clock pulse width, the maximum clock frequency and the output transition times

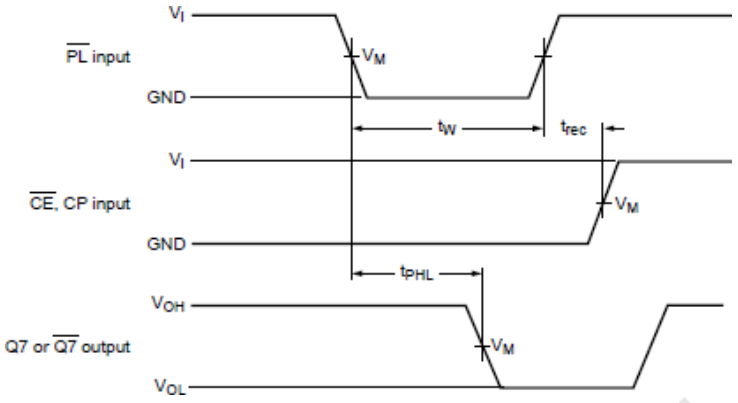


Figure 7. The parallel load ($\overline{PL}$) pulse width, the parallel load to output (Q7 or $\overline{Q7}$) propagation delays, the parallel load to clock (CP) and clock enable ($\overline{CE}$) recovery time

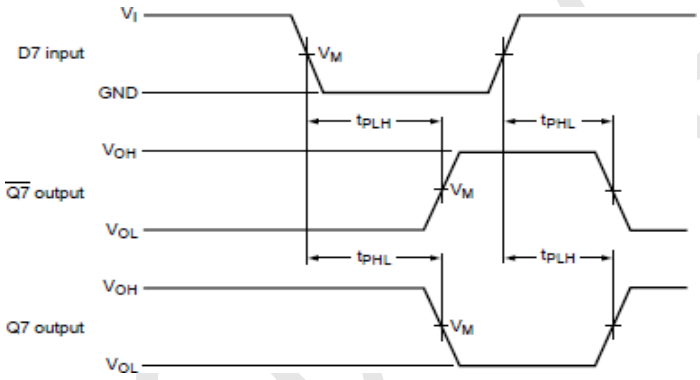


Figure 8. The data input (D7) to output (Q7 or $\overline{Q7}$) propagation delays when $\overline{PL}$ is LOW

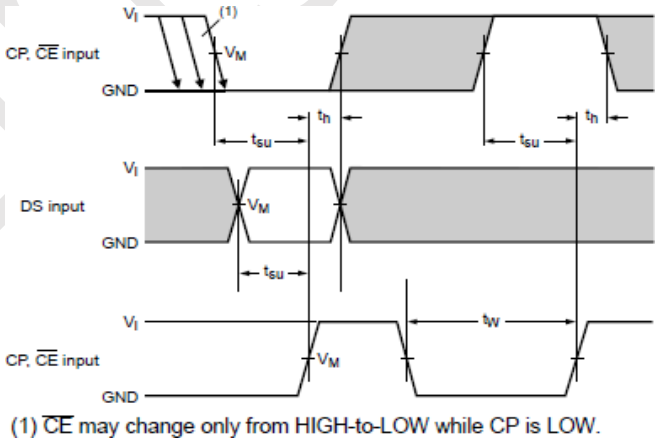


Figure 9. The set-up and hold times from the serial data input (DS) to the clock (CP) and clock enable ($\overline{CE}$) inputs, from the clock enable input ($\overline{CE}$) to the clock input (CP) and from the clock input (CP) to the clock enable input ($\overline{CE}$)

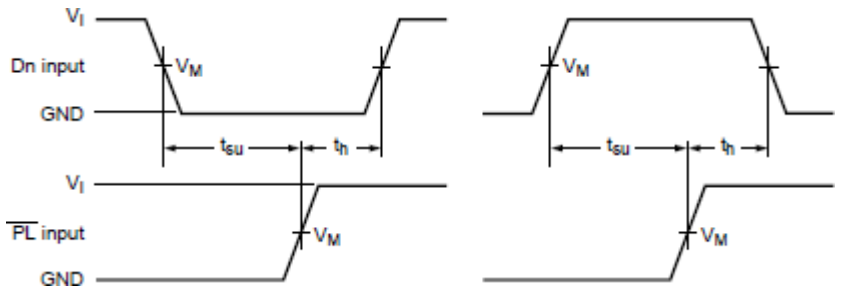


Figure 10. The set-up and hold times from the data inputs (Dn) to the parallel load input ($\overline{PL}$)

4.3、Measurement Points

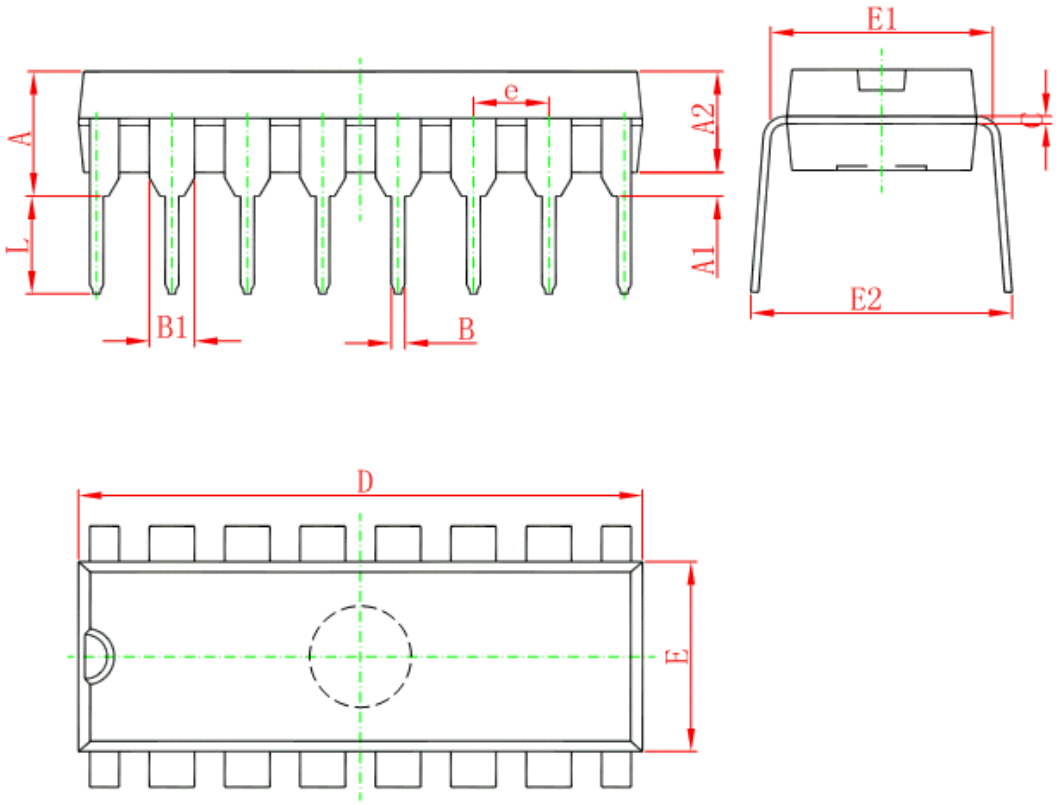
Type	Input		Output
	V_I	V_M	V_M
SN74HC165	V_{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$
SN74HCT165	3V	1.3V	1.3V

4.4、Test Data

Type	Input		Load		S1 position
	V_I	t_r , t_f	C_L	R_L	t_{PHL}, t_{PLH}
SN74HC165	V_{CC}	6.0ns	15pF, 50pF	1kΩ	open
SN74HCT165	3.0V	6.0ns	15pF, 50pF	1kΩ	open

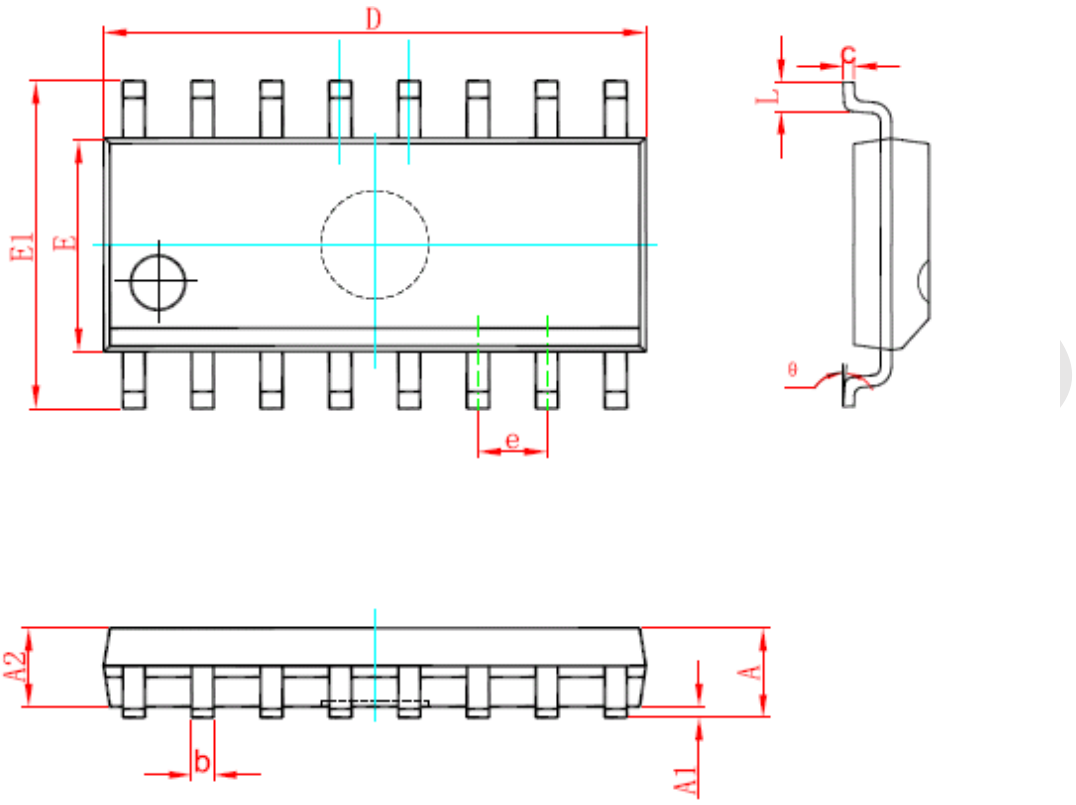
5、Package Information

5.1、DIP16



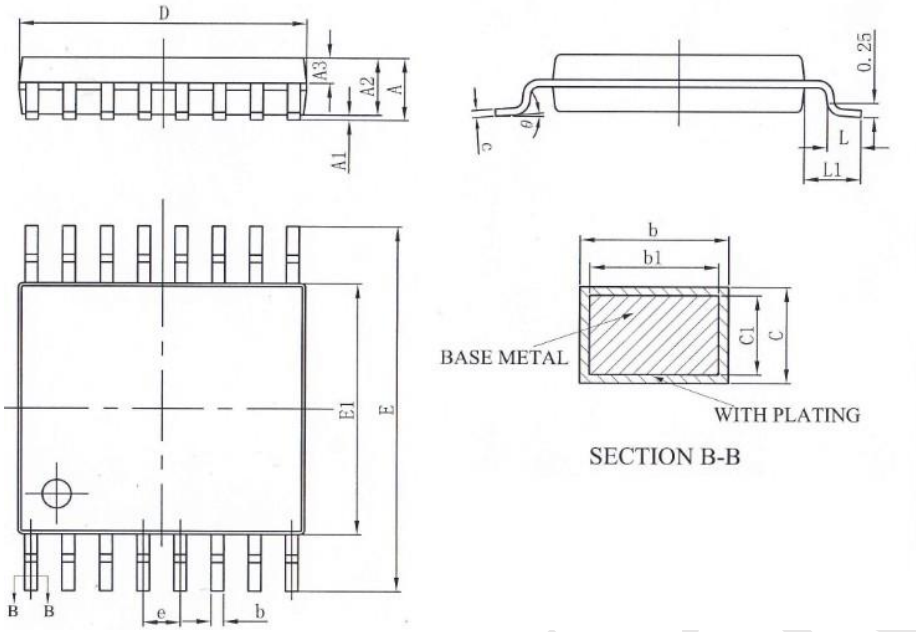
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	3.710	4.310	0.146	0.170
A1	0.510		0.020	
A2	3.200	3.600	0.126	0.142
B	0.380	0.570	0.015	0.022
B1	1.524(BSC)		0.060(BSC)	
C	0.204	0.360	0.008	0.014
D	18.800	19.200	0.740	0.756
E	6.200	6.600	0.244	0.260
E1	7.320	7.920	0.288	0.312
e	2.540(BSC)		0.100(BSC)	
L	3.000	3.600	0.118	0.142
E2	8.400	9.000	0.331	0.354

5.2、SOP16



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	9.800	10.200	0.386	0.402
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

5.3、TSSOP16



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	—	—	1.20
A1	0.05	—	0.15
A2	0.90	1.00	1.05
A3	0.39	0.44	0.49
b	0.20	—	0.28
b1	0.19	0.22	0.25
c	0.13	—	0.17
c1	0.12	0.13	0.14
D	4.90	5.00	5.10
E	6.20	6.40	6.60
E1	4.30	4.40	4.50
e	0.65BSC		
L	0.45	0.60	0.75
L1	1.00BSC		
θ	0	—	8°

6、Statements And Notes

6.1、The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○：Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×：Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

6.2、Notion

Recommended carefully reading this information before the use of this product；

The information in this document are subject to change without notice；

This information is using to the reference only, the company is not responsible for any loss；

The company is not responsible for the any infringement of the third party patents or other rights of the responsibility.